



SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

CPH6121 — PNP Epitaxial Planar Silicon Transistor

DC / DC Converter Applications

Applications

- Relay drivers, lamp drivers, motor drivers, strobes

Features

- Adoption of MBIT process
- High current capacitance
- Low collector-to-emitter saturation voltage
- High speed switching
- Ultrasmall-sized package permitting applied sets to be made small and slim (0.9mm)
- High allowable power dissipation

Specifications

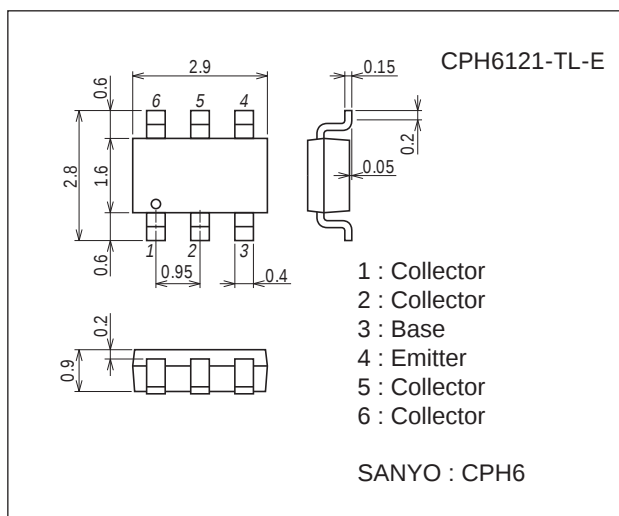
Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Base Voltage	V _{CBO}		-15	V
Collector-to-Emitter Voltage	V _{CEO}		-12	V
Emitter-to-Base Voltage	V _{EBO}		-5	V
Collector Current	I _C		-3	A
Collector Current (Pulse)	I _{CP}		-5	A
Base Current	I _B		-600	mA
Collector Dissipation	P _C	Mounted on a ceramic board (600mm ² ×0.8mm)	1.3	W
Junction Temperature	T _j		150	°C
Storage Temperature	T _{stg}		-55 to +150	°C

Package Dimensions

unit : mm (typ)

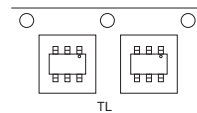
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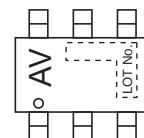
Product & Package Information

- Package : CPH6
- JEITA, JEDEC : SC-74, SOT-26, SOT-457
- Minimum Packing Quantity : 3,000 pcs./reel

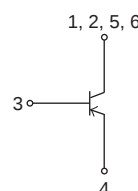
Packing Type: TL



Marking



Electrical Connection



SANYO Semiconductor Co., Ltd.

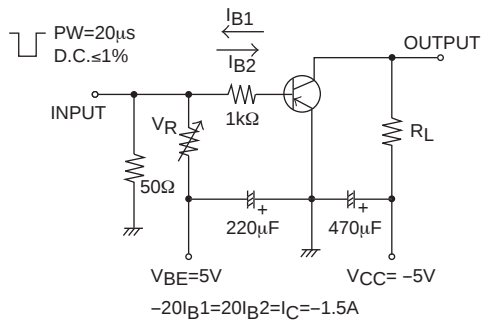
<http://semicon.sanyo.com/en/network>

CPH6121

Electrical Characteristics at Ta=25°C

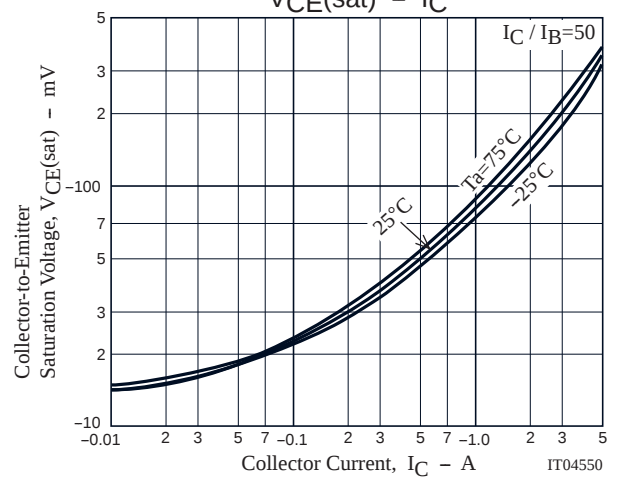
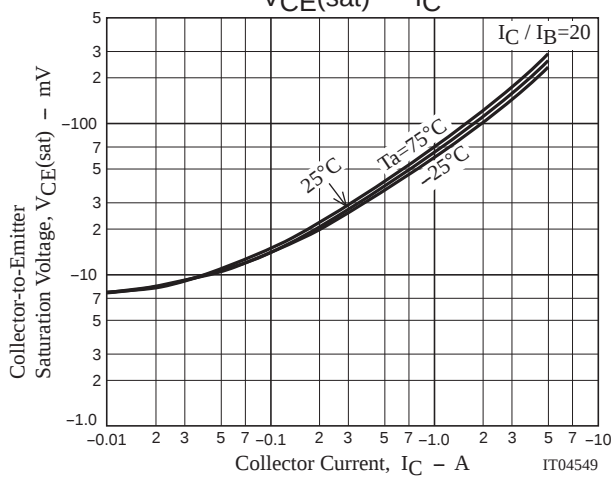
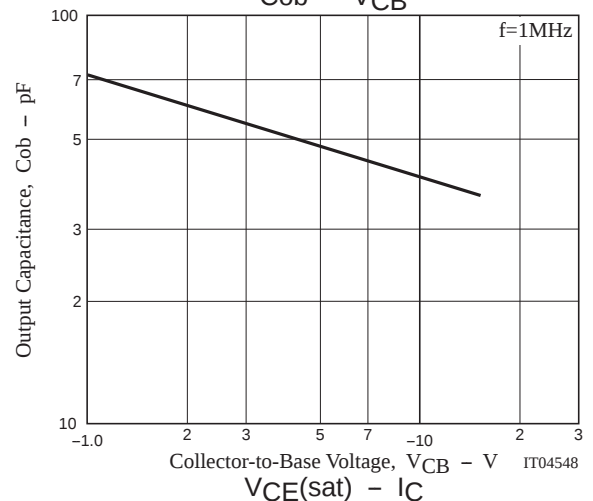
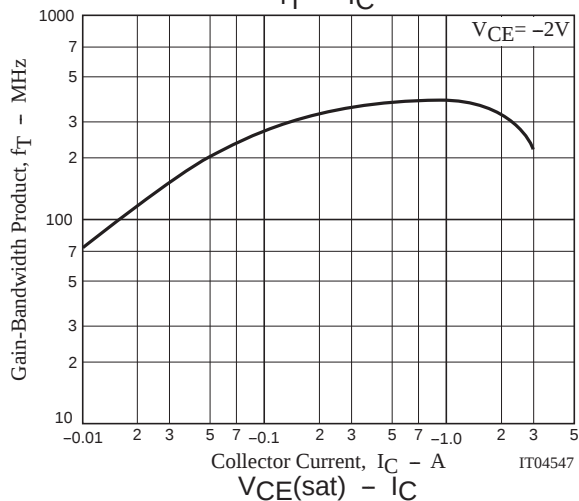
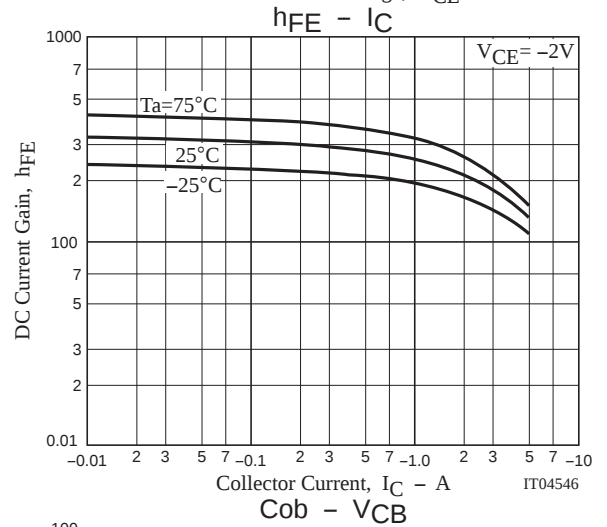
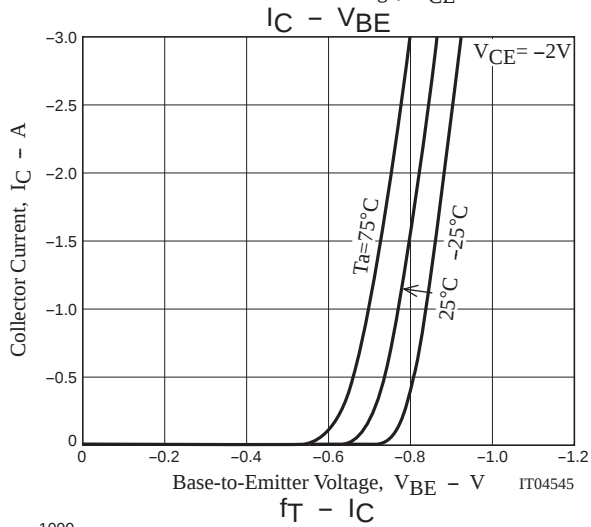
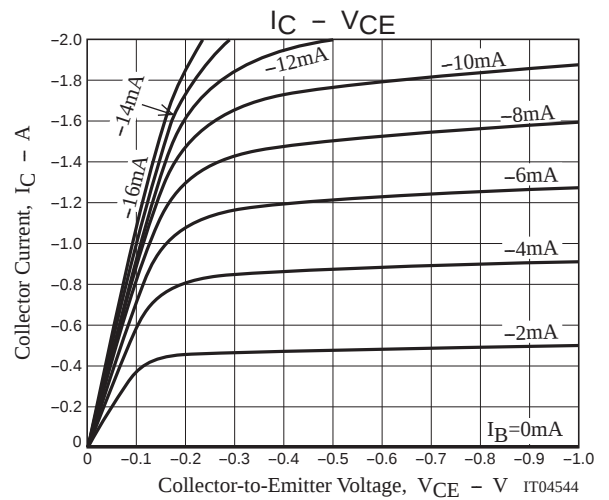
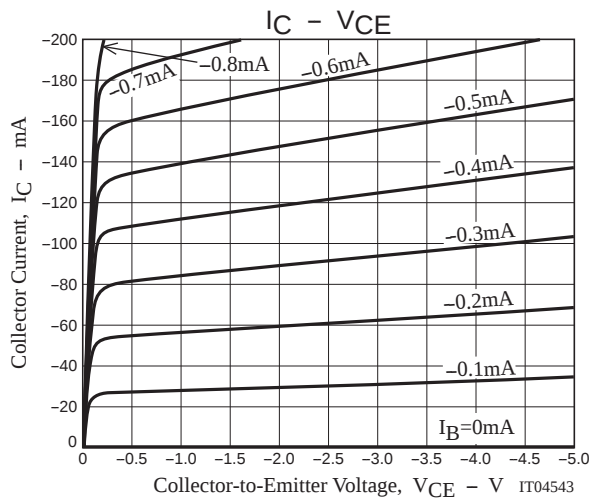
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Collector Cutoff Current	I_{CBO}	$V_{CB} = -12V, I_E = 0A$			-0.1	μA
Emitter Cutoff Current	I_{EBO}	$V_{EB} = -4V, I_C = 0A$			-0.1	μA
DC Current Gain	h_{FE}	$V_{CE} = -2V, I_C = -500mA$	200		560	
Gain-Bandwidth Product	f_T	$V_{CE} = -2V, I_C = -500mA$		380		MHz
Output Capacitance	C_{ob}	$V_{CB} = -10V, f = 1MHz$		40		pF
Collector-to-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C = -1.5A, I_B = -30mA$		-110	-165	mV
Base-to-Emitter Saturation Voltage	$V_{BE(sat)}$	$I_C = -1.5A, I_B = -30mA$		-0.85	-1.2	V
Collector-to-Base Breakdown Voltage	$V_{(BR)CBO}$	$I_C = -10\mu A, I_E = 0A$	-15			V
Collector-to-Emitter Breakdown Voltage	$V_{(BR)CEO}$	$I_C = -1mA, R_{BE} = \infty$	-12			V
Emitter-to-Base Breakdown Voltage	$V_{(BR)EBO}$	$I_E = -10\mu A, I_C = 0A$	-5			V
Turn-On Time	t_{on}	See specified Test Circuit.		30		ns
Storage Time	t_{stg}			90		ns
Fall Time	t_f			14		ns

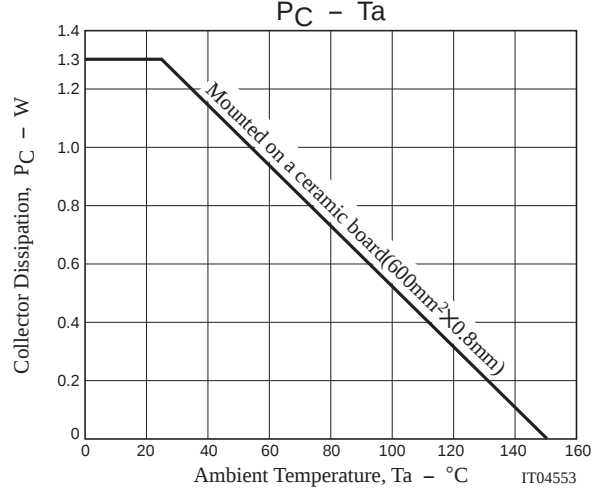
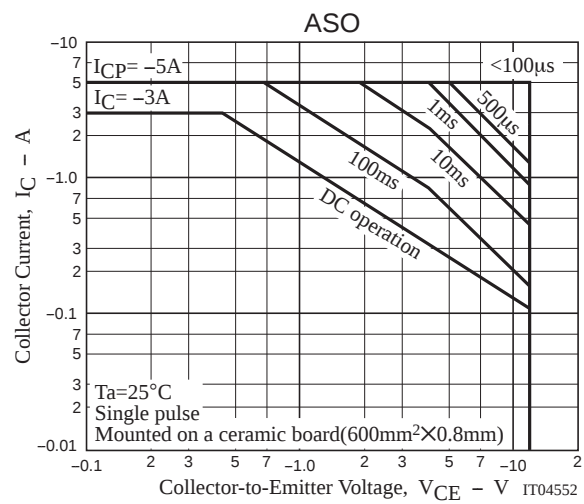
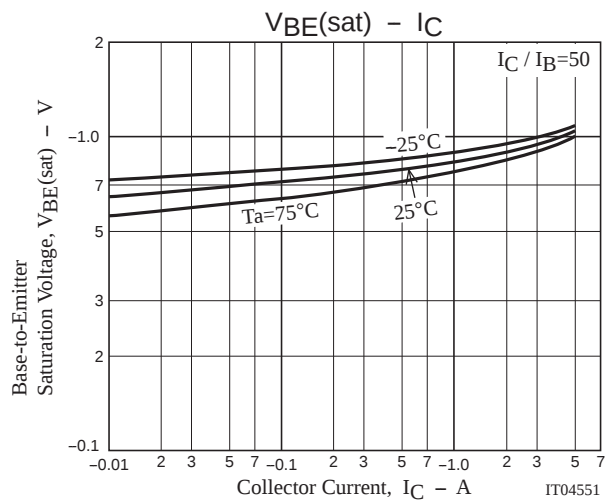
Switching Time Test Circuit



Ordering Information

Device	Package	Shipping	memo
CPH6121-TL-E	CPH6	3,000pcs./reel	Pb Free





Embossed Taping Specification

CPH6121-TL-E

1. Packing Format

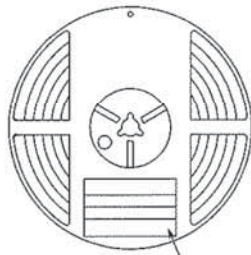
Package Name	Carrier Tape Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
CPH6	CPH6	3,000	15,000	90,000	5 reels contained Dimensions:mm (external) 183×72×185	6 inner boxes contained Dimensions:mm (external) 440×195×210

Reel label, Inner box label
(unit:mm)

Outer box label

It is a label at the time of factory shipments.
The form of a label may change in physical distribution process.

Packing method



Reel label

Type No.
LOT No.
Quantity
Origin

TYPE	000000000
LOT	00
QTY	0,000 (1) LEAD FREE #
SPECIAL	*20722005310C*
ASSEMBLY	**** (DIFFUSION:****)

NOTE (1)

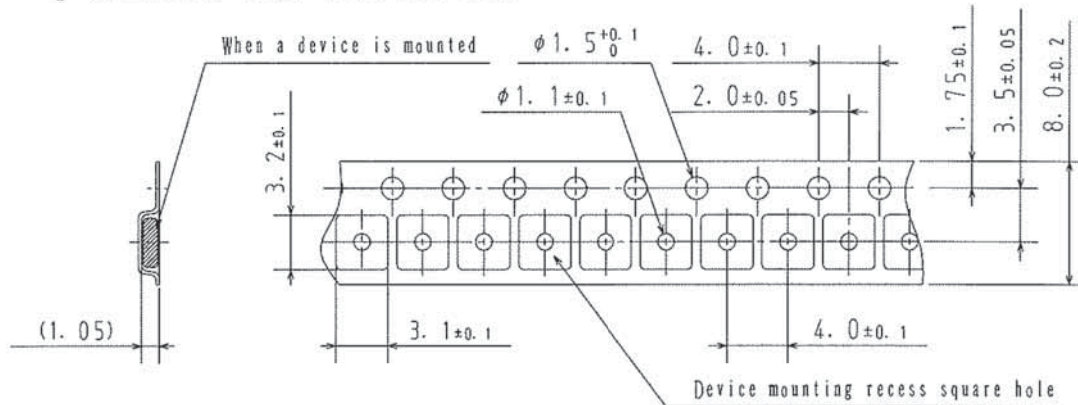
The LEAD FREE # description shows that the surface treatment of the terminal is lead free.

Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3

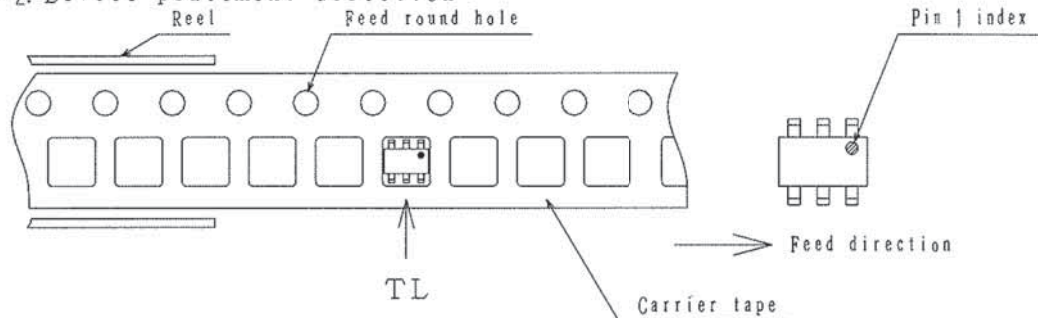
TYPE CODE	*****0*****
TYPE	00000000
QTY	0,000 PCS (1) LEAD FREE #
LOT	00000000
PACKAGE	00000000
SPECIAL	*20722005310C*
ASSEMBLY	**** (DIFFUSION:****)

2. Taping configuration

2-1. Carrier tape size (unit:mm)

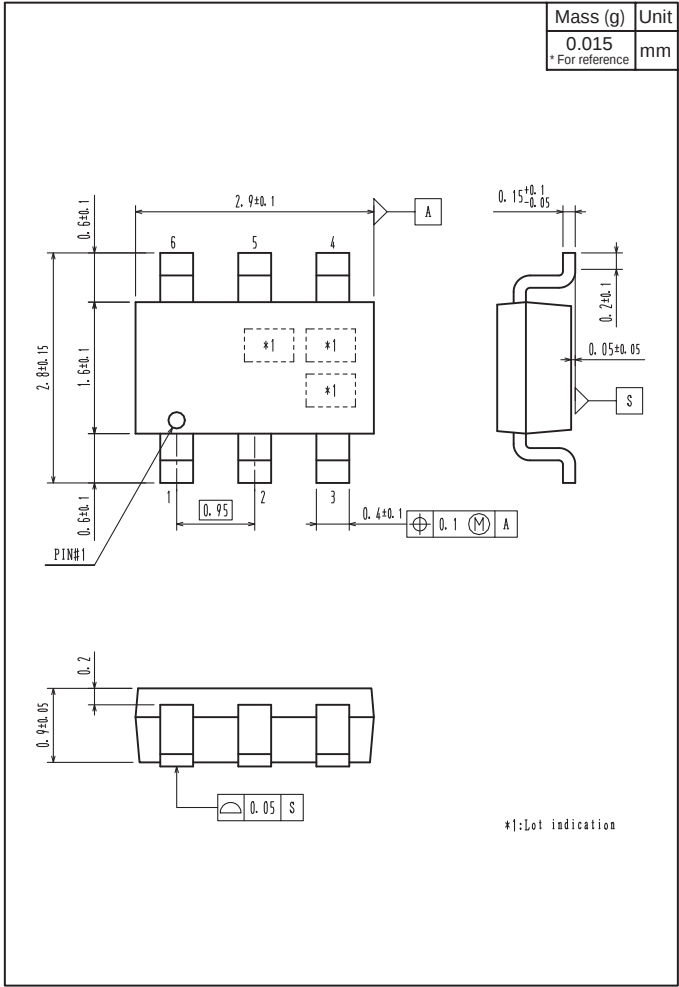


2-2. Device placement direction

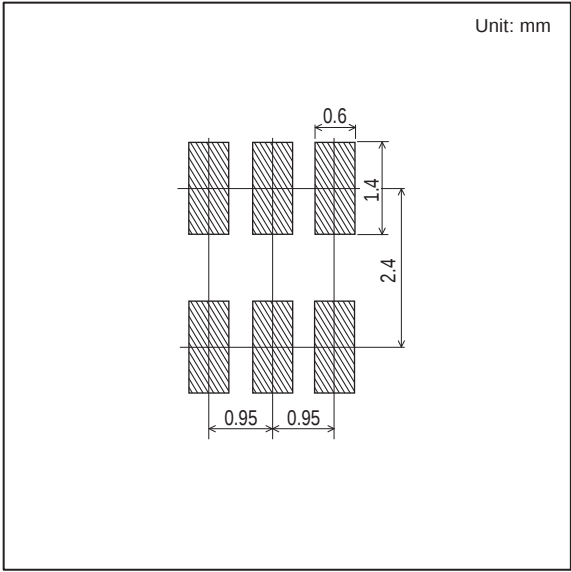


Those with pin 1 index on the feed hole side.....TL

Outline Drawing
CPH6121-TL-E



Land Pattern Example



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